

XC2S600E-6FGG456I

Data Sheet

600,000 SYSTEM GATE 1.8V FPGA - NOT RECOMMENDED for NEW DESIGN

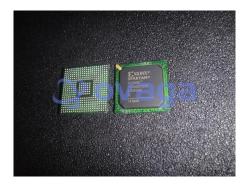
Manufacturers AMD Xilinx, Inc

Package/Case BGA456

Product Type Programmable Logic ICs

RoHS

Lifecycle



Images are for reference only

Please submit RFQ for XC2S600E-6FGG456I or Email to us; sales@ovaga.com We will contact you in 12 hours.



General Description

XC2S600E-6FGG456I is a model number for a specific FPGA (Field Programmable Gate Array) chip produced by Xilinx, which is a leading manufacturer of FPGAs. Here's what the various components of the part number mean:

Features

XC2S600E: This is the model name of the chip, indicating that it belongs to the Spartan-II family of FPGAs produced by Xilinx.

Application

The XC2S600E-6FGG456I has 600,000 system gates, and 1.6 Mb of Block RAM. It is a low-power FPGA, designed to minimize power consumption while still providing high performance.

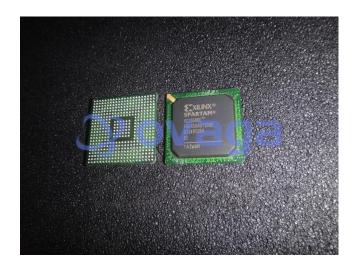
6: This indicates the speed grade of the chip. A higher number It supports a range of communication protocols such as PCI, SPI, and Ethernet. indicates a faster chip.

FGG456: This is the package type, which indicates the physical form factor of the chip. In this case, FGG456 is a 456-ball grid array package.

I: This indicates the temperature range in which the chip can operate. In this case, it is the industrial temperature range.

It has an on-chip oscillator, JTAG programming support, and multiple power-saving modes.

The chip is designed to operate at a maximum clock frequency of 250 MHz.



Related Products



XC18V01S020C

AMD Xilinx, Inc SOP-20



XCF04SV0G20C

AMD Xilinx, Inc TSSOP20



XC6SLX4-2CSG225C

AMD Xilinx, Inc BGA-225



XCV50-6BG256C

AMD Xilinx, Inc BGA256



XCF08PV0G48C

AMD Xilinx, Inc TSOP-48



XC6SLX25-3FTG256C

AMD Xilinx, Inc BGA-256



XC6SLX16-3CSG324C

AMD Xilinx, Inc BGA-324



XCF32PVO48C

AMD Xilinx, Inc TSOP48